

## LO566TYL1-60H

### Features

All Plastic Mold Type  
High Luminous Intensity  
Low Current Requirement

### Applications

Backlighting  
Full Color/RGB Video Signs  
VMS  
Time/Temperature Boards



## ATTENTION

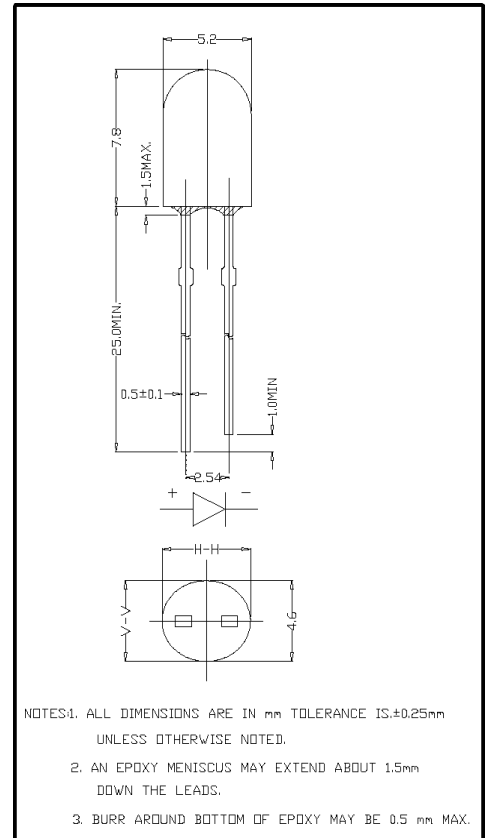
OBSERVE PRECAUTIONS  
ELECTROSTATIC  
SENSITIVE DEVICES

### Maximum Ratings (Ta=25°C)

Characteristic	Symbol	Max.	Unit
Forward Current	I <sub>F</sub>	50	mA
Reverse Voltage	V <sub>R</sub>	5	V
Power Dissipation	P <sub>D</sub>	150.00	mW
Operating Temperature	T <sub>opr</sub>	-40 ~ +95	°C
Storage Temperature	T <sub>stg</sub>	-40 ~ +95	°C
Soldering Temperature	T <sub>sol</sub>	260	°C
Soldering Time	-	for 5 sec. max	-

### Opto-Electrical Characteristics (Ta=25°C)

Characteristic	Symbol	Test Condition	Min	Typ	Max	Unit
Forward Voltage	V <sub>F</sub>	I <sub>F</sub> =20mA	1.70	2.10	2.60	V
Reverse Current	I <sub>R</sub>	V <sub>R</sub> =5V	-	-	100	μA
Luminous Intensity	I <sub>v</sub>	I <sub>F</sub> =20mA	550.00	1000.00	-	mcd
Viewing Angle	2θ <sup>1/2</sup>	-	-	60° x 35°	-	deg.
Peak Wavelength	λ <sub>p</sub>	I <sub>F</sub> =20mA	-	594	-	nm
Dominant Wavelength	λ <sub>d</sub>	I <sub>F</sub> =20mA	-	591	-	nm
Spectral Line Half Width	Δλ	I <sub>F</sub> =20mA	-	20	-	nm



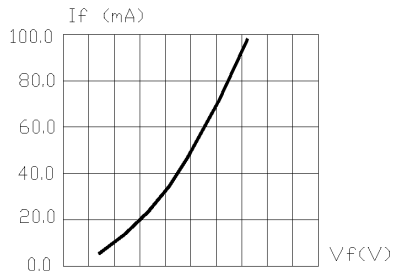


FIG.1 FORWARD CURRENT VS. FORWARD VOLTAGE.

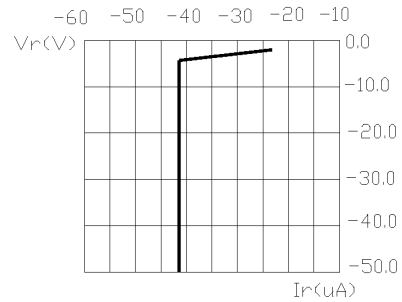


FIG.2 REVERSE CURRENT VS. REVERSE VOLTAGE.

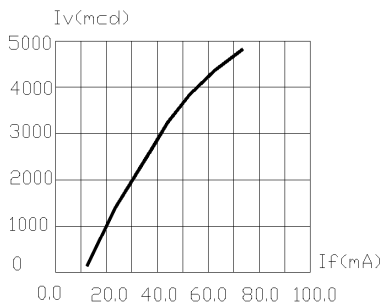


FIG.3 RELATIVE LUMINOUS INTENSITY VS. FORWARD CURRENT.

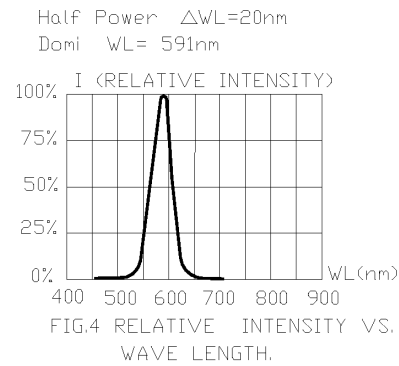


FIG.4 RELATIVE INTENSITY VS. WAVE LENGTH.

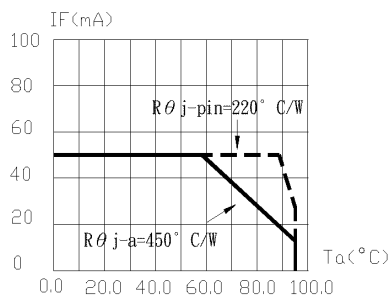


FIG.5 MAXIMUM FORWARD DC CURRENT VS TEMPERATURE. DERATING BASED ON  $T_{jmax} = 105^\circ\text{C}$

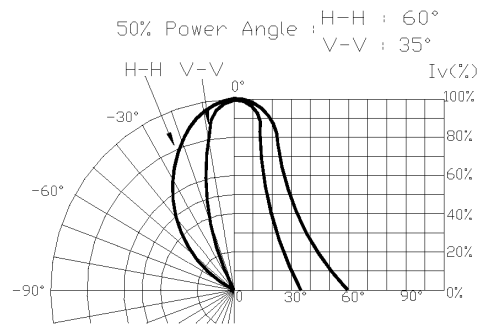


FIG.6 SPATIAL DISTRIBUTION.

1. Cathode PAD Area (0.18 x 0.18 inch<sup>2</sup>)
2. Height above nominal seating plane in inches (0.3 inch)